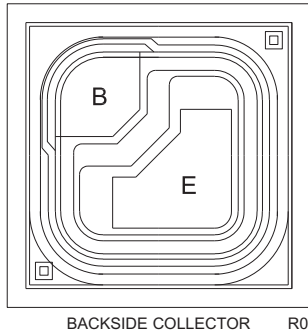


CP788X-2N5087

PNP - General Purpose Transistor Die

The CP788X-2N5087 is a silicon PNP transistor designed for general purpose applications.



MECHANICAL SPECIFICATIONS:

Die Size	13.7 x 13.7 MILS
Die Thickness	5.9 MILS
Base Bonding Pad Size	4.0 x 4.0 MILS
Emitter Bonding Pad Size	5.5 x 5.5 MILS
Top Side Metalization	Al-Si – 17,000Å
Back Side Metalization	Au – 9,000Å
Scribe Alley Width	1.8 MILS
Wafer Diameter	5 INCHES
Gross Die Per Wafer	91,469

MAXIMUM RATINGS: (T_A=25°C)

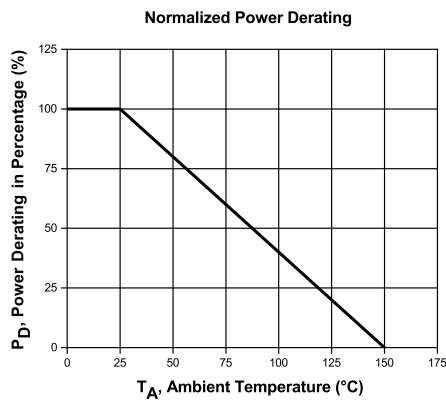
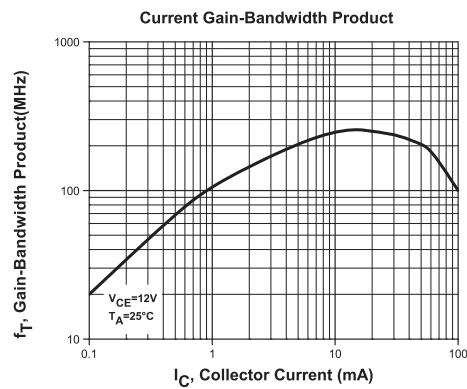
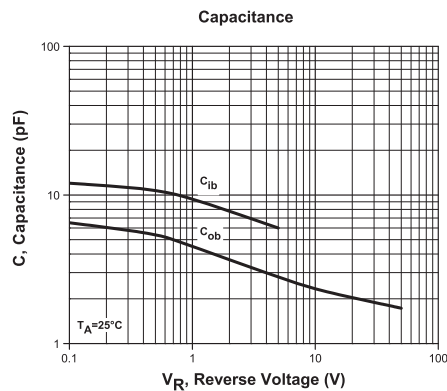
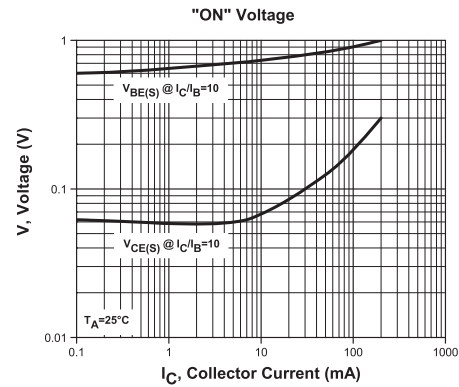
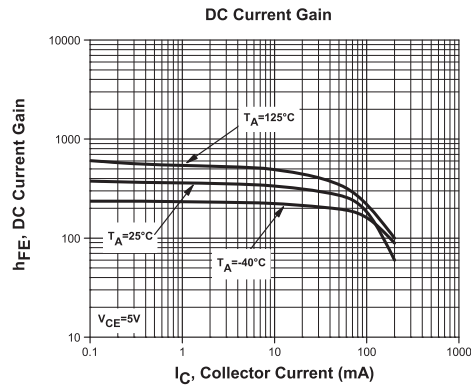
	SYMBOL		UNITS
Collector-Base Voltage	V _{CBO}	50	V
Collector-Emitter Voltage	V _{CEO}	50	V
Emitter-Base Voltage	V _{EBO}	3.0	V
Continuous Collector Current	I _C	50	mA
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C

ELECTRICAL CHARACTERISTICS: (T_A=25°C)

SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I _{CBO}	V _{CB} =35V		50	nA
I _{EBO}	V _{EB} =3.0V		50	nA
BV _{CBO}	I _C =100μA	50		V
BV _{CEO}	I _C =1.0mA	50		V
V _{CE(SAT)}	I _C =10mA, I _B =1.0mA		0.30	V
V _{BE(ON)}	V _{CE} =5.0V, I _C =1.0mA		0.85	V
h _{FE}	V _{CE} =5.0V, I _C =100μA	250	800	
h _{FE}	V _{CE} =5.0V, I _C =1.0mA	250		
h _{FE}	V _{CE} =5.0V, I _C =10mA	250		
f _T	V _{CE} =5.0V, I _C =500μA, f=20MHz	40		MHz
C _{ob}	V _{CB} =5.0V, I _E =0, f=100kHz		4.0	pF

CP788X-2N5087

Typical Electrical Characteristics





PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp.
145 Adams Avenue
Hauppauge, NY 11788 USA
Main Tel: (631) 435-1110
Main Fax: (631) 435-1824
Support Team Fax: (631) 435-3388
www.centalsemi.com

Worldwide Field Representatives:
www.centalsemi.com/wwreps

Worldwide Distributors:
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